

## Silicon Carbide Power Schottky Diode

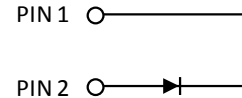
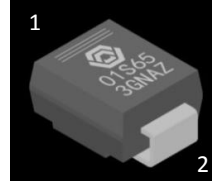
$V_{RRM}$	=	650 V
$I_F (T_C = 25^\circ\text{C})$	=	2.5 A
$I_F (T_C \leq 150^\circ\text{C})$	=	1 A
$Q_C$	=	7 nC

### Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of  $V_F$
- Extremely fast switching speeds
- Superior figure of merit  $Q_C/I_F$

### Package

- RoHS Compliant



**DO – 214AA**

### Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

### Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

### Maximum Ratings at $T_j = 175^\circ\text{C}$ , unless otherwise specified

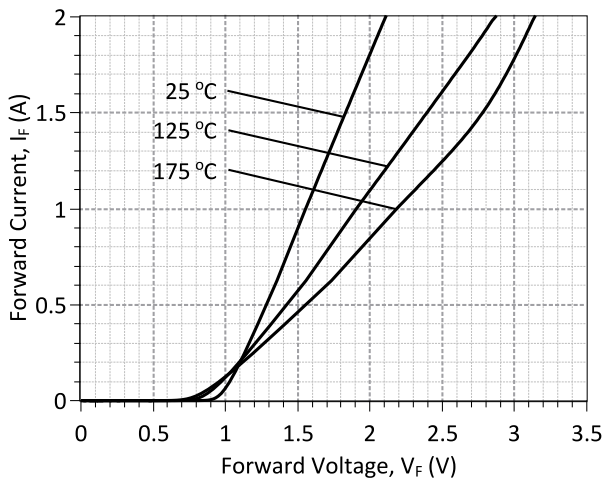
Parameter	Symbol	Conditions	Values		Unit
			min.	typ.	
Repetitive peak reverse voltage	$V_{RRM}$			650	V
Continuous forward current	$I_F$	$T_C = 25^\circ\text{C}$		2.5	A
Continuous forward current	$I_F$	$T_C \leq 150^\circ\text{C}$		1	A
RMS forward current	$I_{F(RMS)}$	$T_C \leq 150^\circ\text{C}$		2	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$		10	A
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25^\circ\text{C}, t_p = 10\ \mu\text{s}$		65	A
$I^2t$ value	$\int i^2 dt$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$		0.5	$\text{A}^2\text{S}$
Power dissipation	$P_{tot}$	$T_C = 25^\circ\text{C}$		64	W
Operating and storage temperature	$T_j, T_{stg}$			-55 to 175	$^\circ\text{C}$

### Electrical Characteristics at $T_j = 175^\circ\text{C}$ , unless otherwise specified

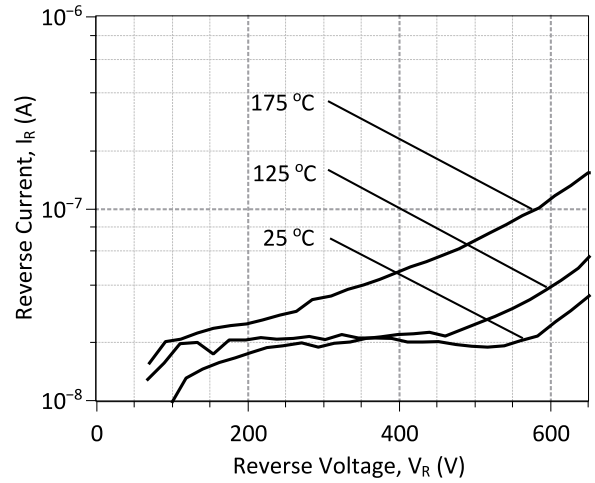
Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	$V_F$	$I_F = 1\text{ A}, T_j = 25^\circ\text{C}$		1.5	2.0	V
		$I_F = 1\text{ A}, T_j = 175^\circ\text{C}$		2.3	3.0	
Reverse current	$I_R$	$V_R = 650\text{ V}, T_j = 25^\circ\text{C}$		1	10	$\mu\text{A}$
		$V_R = 650\text{ V}, T_j = 175^\circ\text{C}$		5	50	
Total capacitive charge	$Q_C$	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200\text{ A}/\mu\text{s}$ $T_j = 175^\circ\text{C}$		7		nC
Switching time	$t_s$	$V_R = 400\text{ V}$ $V_R = 400\text{ V}$		< 20		ns
Total capacitance	C	$V_R = 1\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$		76		pF
		$V_R = 400\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$		12		

### Thermal Characteristics

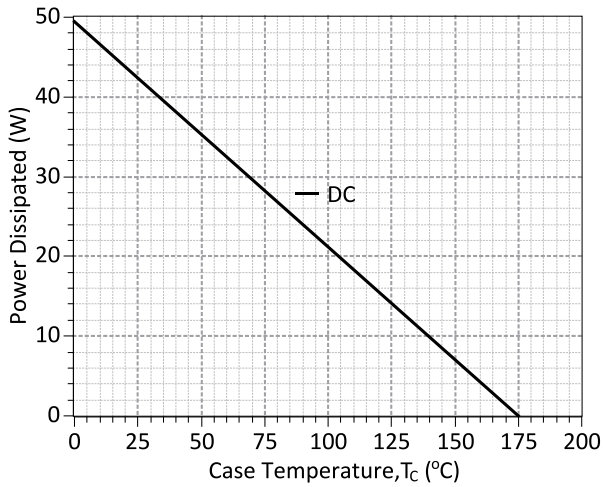
Thermal resistance, junction - case	$R_{thJC}$	3.55	$^\circ\text{C}/\text{W}$
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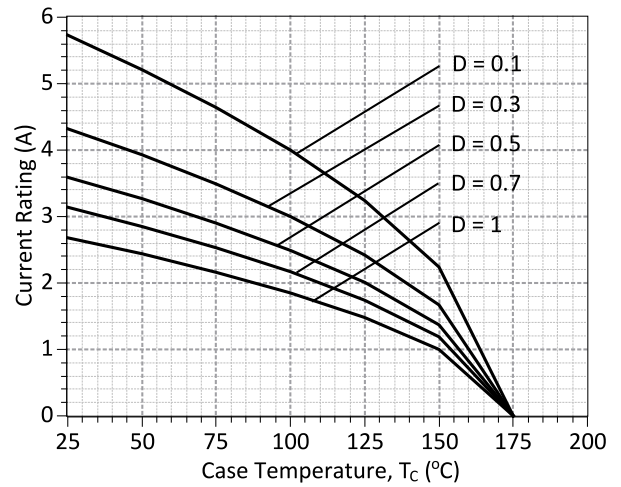
**Figure 1: Typical Forward Characteristics**



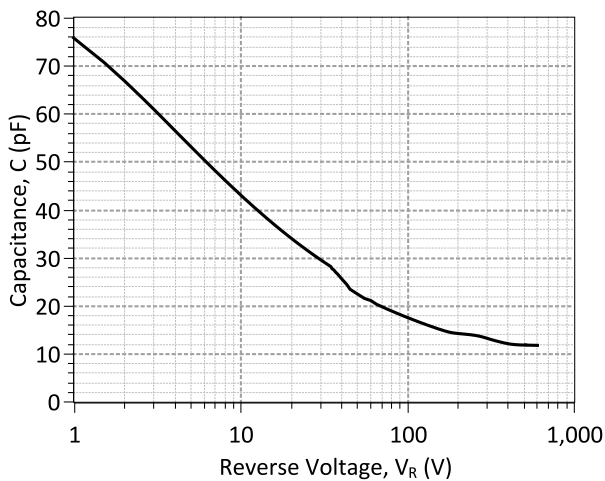
**Figure 2: Typical Reverse Characteristics**



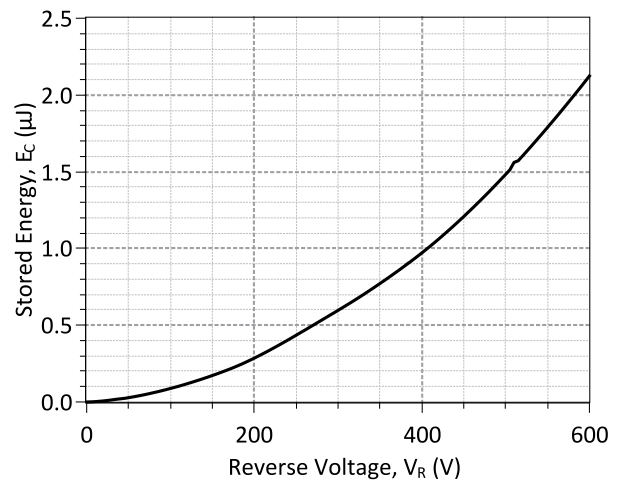
**Figure 3: Power Derating Curve**



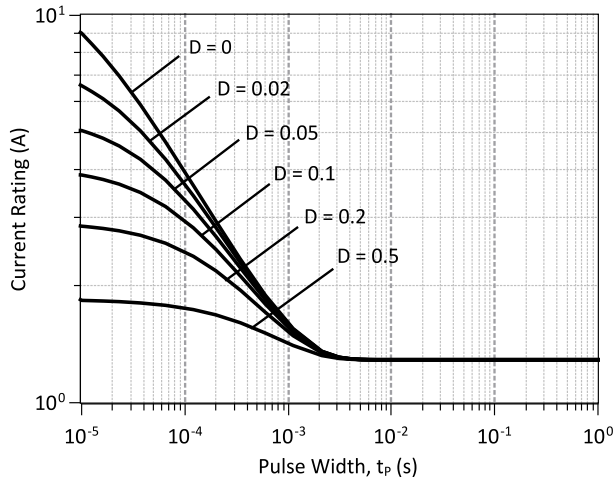
**Figure 4: Current Derating Curves ( $D = t_P/T$ ,  $t_P = 400 \mu s$ )  
(Considering worst case  $Z_{th}$  conditions)**



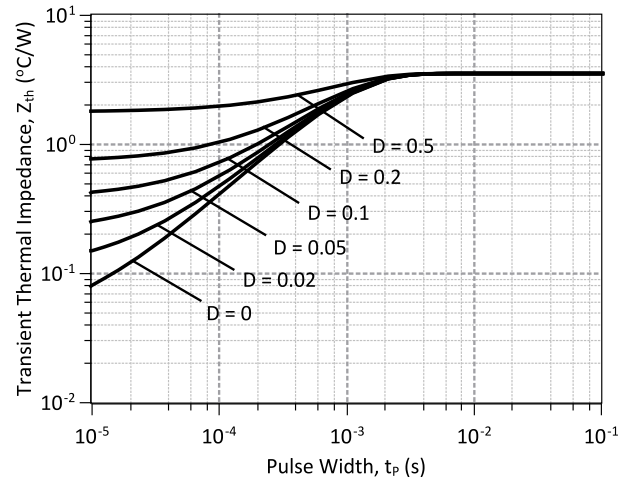
**Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics**



**Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics**



**Figure 7: Current vs Pulse Duration Curves at  $T_C = 160\text{ }^\circ\text{C}$**

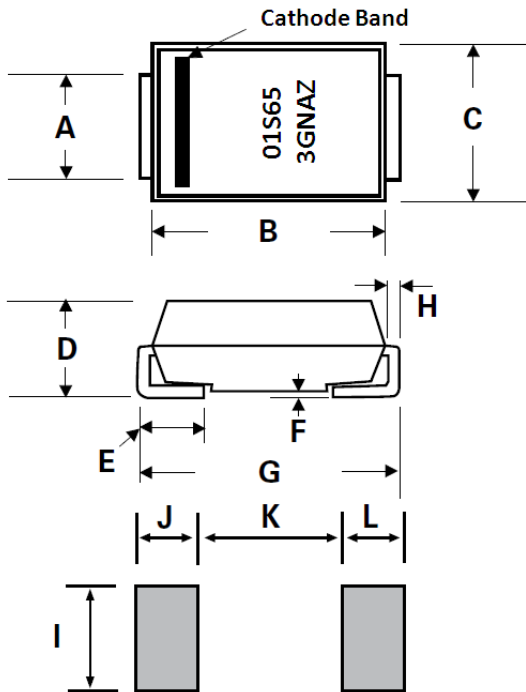


**Figure 8: Transient Thermal Impedance**

**Package Dimensions:**

**DO-214AA**

**PACKAGE OUTLINE**



Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.077	0.086	1.950	2.200
B	0.160	0.180	4.060	4.570
C	0.130	0.155	3.300	3.940
D	0.084	0.096	2.130	2.440
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.205	0.220	5.210	5.590
H	0.006	0.012	0.152	0.305
I	0.089	-	2.260	-
J	0.085	-	2.160	-
K	-	0.107	-	2.740
L	0.085	-	2.160	-

**NOTE**

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

**Revision History**

Date	Revision	Comments	Supersedes
2014/08/26	1	Updated Electrical Characteristics	
2013/09/09	0	Initial release	

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## SPICE Model Parameters

This is a secure document. Please copy this code from the SPICE model PDF file on our website ([http://www.genesicsemi.com/images/products\\_sic/rectifiers/GB01SLT06-214\\_SPICE.pdf](http://www.genesicsemi.com/images/products_sic/rectifiers/GB01SLT06-214_SPICE.pdf)) into LTSPICE (version 4) software for simulation of the GB01SLT06-214.

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*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:   1.0           $
*      $Date:      09-SEP-2013   $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
*      COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
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*
*      These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
*      OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
*      TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
*      PARTICULAR PURPOSE."
*      Models accurate up to 2 times rated drain current.
*
*      Start of GB01SLT06-214 SPICE Model
*
.SUBCKT GB01SLT06 ANODE KATHODE
D1 ANODE KATHODE GB01SLT06_25C; Call the Schottky Diode Model
D2 ANODE KATHODE GB01SLT06_PIN; Call the PiN Diode Model
.MODEL GB01SLT06_25C D
+ IS      3.57E-18      RS      0.49751
+ TRS1    0.0057       TRS2    2.40E-05
+ N       1            IKF     322
+ EG      1.2          XTI     3
+ CJO     9.12E-11     VJ     0.371817384
+ M       1.527759838  FC      0.5
+ TT      1.00E-10     BV     650
+ IBV     1.00E-03     VPK    650
+ IAVE    1            TYPE    SiC_Schottky
+ MFG     GeneSiC_Semiconductor
.MODEL GB01SLT06_PIN D
+ IS      5.73E-11     RS      0.72994
+ N       5            IKF     800
+ EG      3.23         XTI     -14
+ FC      0.5          TT      0
+ BV     650           IBV     1.00E-03
+ VPK    650           IAVE    1
+ TYPE    SiC_PiN
.ENDS
*
*      End of GB01SLT06-214 SPICE Model
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